

Electronic Patent Application Fee Transmittal

Application Number:	10666742			
Filing Date:	19-Sep-2003			
Title of Invention:	METHODS FOR THINNING SEMICONDUCTOR SUBSTRATES THAT EMPLOY SUPPORT STRUCTURES FORMED ON THE SUBSTRATES			
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Filer:	Laurence Blair Bond/Karen Olsen			
Attorney Docket Number:	2269-6095US (03-0593.00/U)			
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Utility under 35 USC 111(a) Filing Fees				
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Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
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